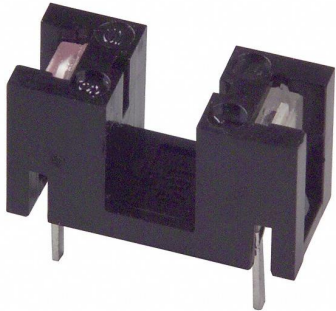


# GP1S561 Datasheet

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DiGi Electronics Part Number	GP1S561-DG
Manufacturer	<a href="#">Sharp Microelectronics</a>
Manufacturer Product Number	GP1S561
Description	SENSOR OPT SLOT PHOTOTRAN PCB MT
Detailed Description	Optical Sensor Through-Beam 0.118" (3mm) Photo transistor PCB Mount

This model GP1S561 is available at DiGi Electronics.

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DiGi is a global authorized distributor of electronic components.

## Purchase and inquiry

Manufacturer Product Number:

GP1S561

Series:

-

Sensing Distance:

0.118" (3mm)

Output Configuration:

Phototransistor

Current - Collector (Ic) (Max):

20 mA

Response Time:

3µs, 4µs

Mounting Type:

Through Hole

Type:

Unamplified

Manufacturer:

Sharp Microelectronics

Product Status:

Obsolete

Sensing Method:

Through-Beam

Current - DC Forward (If) (Max):

50 mA

Voltage - Collector Emitter Breakdown (Max):

35 V

Operating Temperature:

-25°C ~ 85°C

Package / Case:

PCB Mount

## Environmental & Export classification

RoHS Status:

RoHS non-compliant

ECCN:

EAR99

Moisture Sensitivity Level (MSL):

1 (Unlimited)

HTSUS:

8541.49.8000

# GP1S561

## Compact and Thin Photointerrupter

### ■ Features

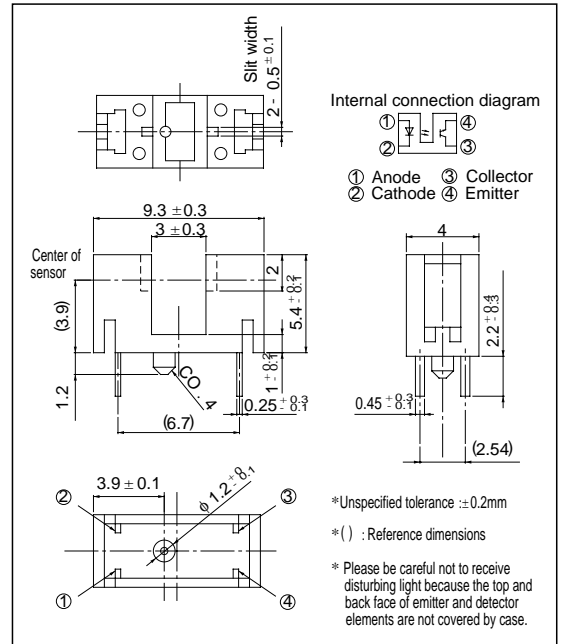
1. Compact and thin package  
(Thickness of case: 4mm)
2. With a positioning pin

### ■ Applications

1. Floppy disk Ratings drivers
2. VCRs

### ■ Outline Dimensions

( Unit : mm )



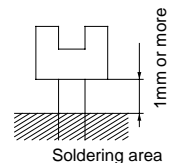
### ■ Absolute Maximum Ratings

( $T_a = 25^\circ\text{C}$ )

Parameter		Symbol	Rating	Unit
Input	Forward current	$I_F$	50	mA
	*1 Peak forward current	$I_{FM}$	1	A
	Reverse voltage	$V_R$	6	V
	Power dissipation	P	75	mW
Output	Collector-emitter voltage	$V_{CEO}$	35	V
	Emitter-collector voltage	$V_{ECO}$	6	V
	Collector current	$I_C$	20	mA
	Collector power dissipation	$P_C$	75	mW
Operating temperature		$T_{opr}$	- 25 to + 85	$^\circ\text{C}$
Storage temperature		$T_{stg}$	- 40 to + 100	$^\circ\text{C}$
*2 Soldering temperature		$T_{sol}$	260	$^\circ\text{C}$

\*1 Pulse width  $\leq 100\mu\text{s}$ , Duty ratio: 0.01

\*2 For 3 seconds



■ Electro-optical characteristics

( $T_a = 25^\circ\text{C}$ )

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit	
Input	Forward voltage	$V_F$	$I_F = 20\text{mA}$	-	1.25	1.4	V	
	Peak forward voltage	$V_{FM}$	$I_{FM} = 0.5\text{A}$	-	3	4	V	
	Reverse current	$I_R$	$V_R = 3\text{V}$	-	-	10	$\mu\text{A}$	
Output	Collector dark current	$I_{CEO}$	$V_{CE} = 20\text{V}$	-	1	100	nA	
Transfer characteristics	Collector current	$I_C$	$V_{CE} = 10\text{V}, I_F = 9\text{mA}$	0.3	-	6	mA	
	Collector-emitter saturation voltage	$V_{CE(sat)}$	$I_F = 40\text{mA}, I_C = 0.1\text{mA}$	-	-	0.4	V	
	Response time	Rise time	$t_r$	$V_{CE} = 2\text{V}, I_C = 1\text{mA}$	-	3	15	$\mu\text{s}$
		Fall time	$t_f$	$R_L = 100\Omega$	-	4	20	$\mu\text{s}$

Fig. 1 Forward Current vs. Ambient Temperature

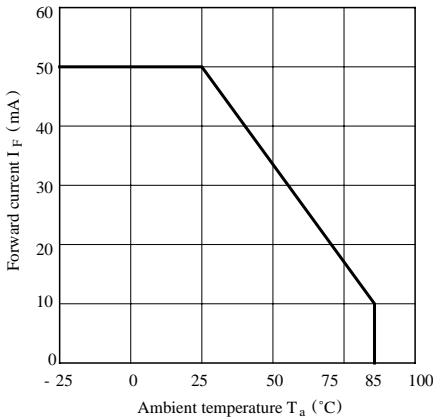


Fig. 2 Collector Power Dissipation vs. Ambient Temperature

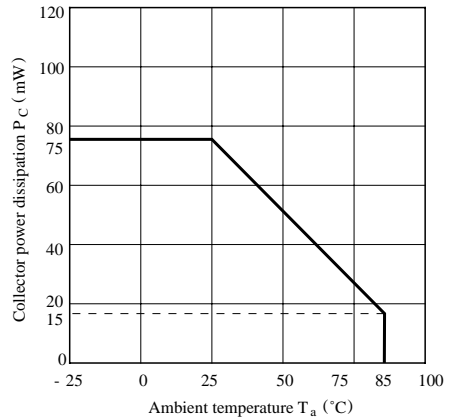


Fig. 3 Peak Forward Current vs. Duty Ratio

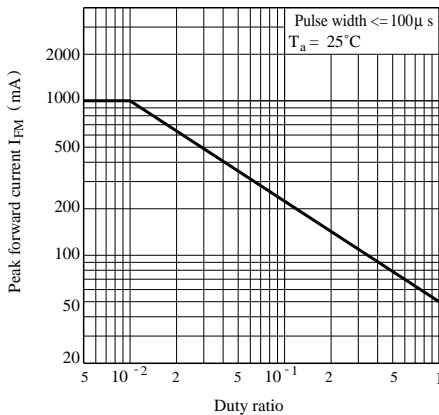
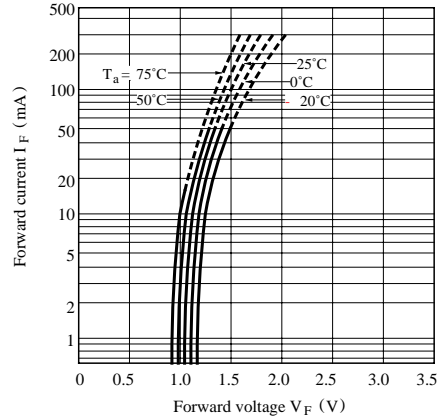
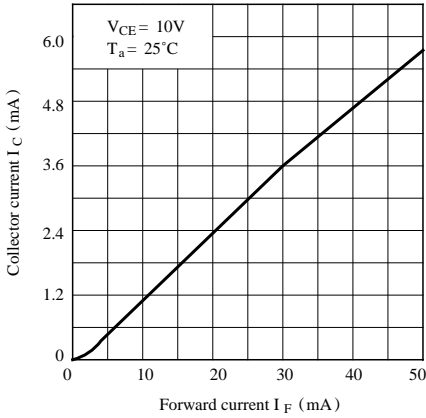


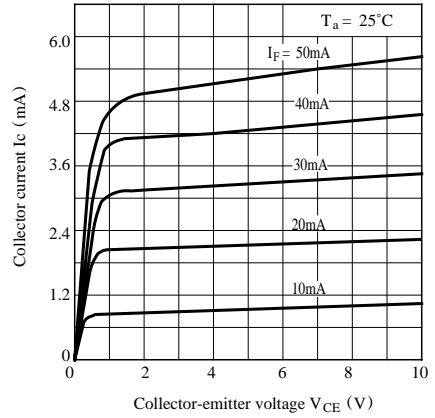
Fig. 4 Forward Current vs. Forward Voltage



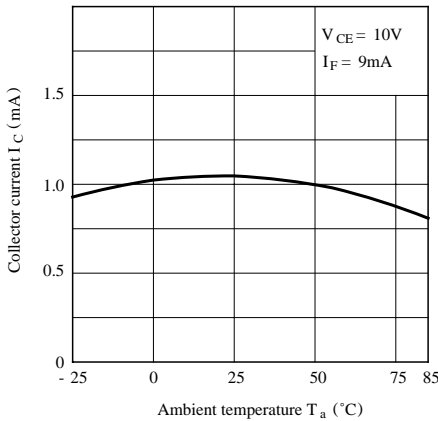
**Fig. 5 Collector Current vs. Forward Current**



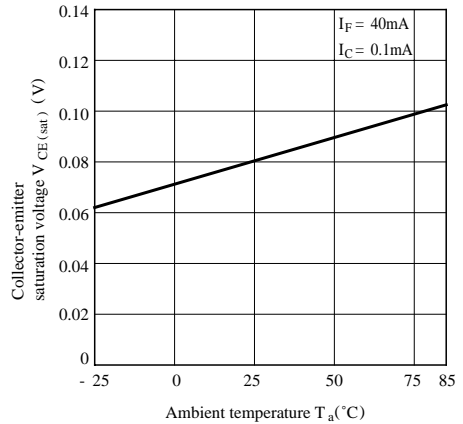
**Fig. 6 Collector Current vs. Collector-emitter Voltage**



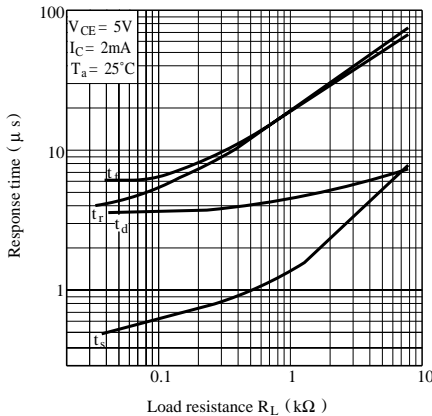
**Fig. 7 Collector Current vs. Ambient Temperature**



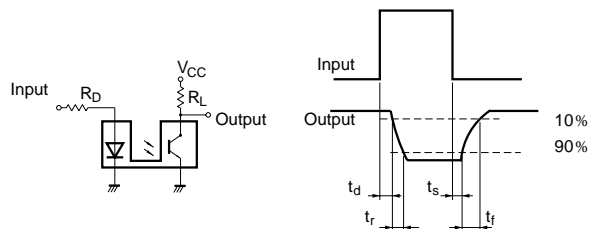
**Fig. 8 Collector-emitter Saturation Voltage vs. Ambient Temperature**



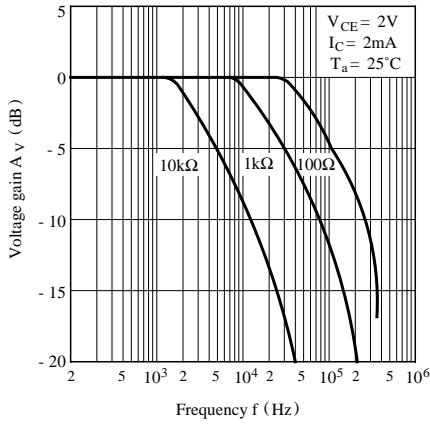
**Fig. 9 Response Time vs. Load Resistance**



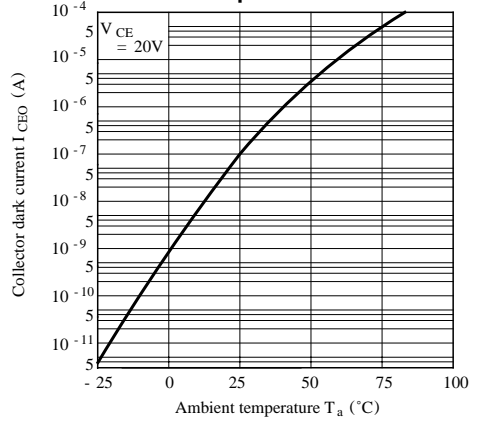
**Test Circuit for Response Time**



**Fig.10 Frequency Response**



**Fig.11 Collector Dark Current vs. Ambient Temperature**



- Please refer to the chapter “Precautions for Use”.

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    - Alarm equipment
    - Various safety devices, etc.
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